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### DESCRIPTION

The MP2636 is a highly-integrated, flexible switch-mode battery charger with system power path management, designed for single-cell Li-ion or Li-Polymer batteries used in a wide range of portable applications.

The MP2636 can operate in both charge mode and boost mode to allow full system management and battery power management.

When input power is present, the device operates in charge mode. It automatically detects the battery voltage and charges the battery in three phases: trickle current, constant current and constant voltage. Other features include charge termination and auto-recharge. This device also integrates both input current limit and input voltage regulation in order to manage input power and meet the priority of the system power demand.

In the absence of an input source, the MP2636 switches to boost mode through the MODE pin to power the SYS pins from the battery. The OLIM pin programs the output current limit in boost mode. The MP2636 also allows an output short circuit protection to completely disconnect the battery from the load in the event of a short circuit fault. Normal operation will recover as soon as the short circuit fault is removed. The MP2636 provides full operating status indication to distinguish charge mode from boost mode. In addition, the MP2636 can report the real battery current in both charge and boost mode via IB pin.

The MP2636 achieves good EMI/EMC performance with well controlled switching edges.

To guarantee safe operation, the MP2636 limits the die temperature to a preset value of 120°C. Other safety features include input over-voltage protection, battery over-voltage protection, thermal shutdown, battery temperature monitoring, and a programmable timer to prevent prolonged charging of a dead battery.

### FEATURES

- Up to 16V Sustainable Input Voltage
- 4.5V-to-6V Operation Voltage Range
- Power Management Function, Integrated Input-Current Limit, Input Voltage Regulation
- Up to 3.0A Programmable Charge Current
- Trickle-Charge Function
- Analog Voltage Output IB pin for Battery Current Monitor
- Selectable 4.2V / 4.3V / 4.35V Charge Voltage with 0.5% Accuracy
- Negative Temperature Coefficient Pin for Temperature Monitoring
- Programmable Timer Back-up Protection
- Thermal Regulation and Thermal Shutdown
- Internal Battery Reverse Leakage Blocking
- Integrated Over Current Protection and Over Voltage Protection for Pass-through Path
- Reverse Boost Operation Mode for System Power
- Up to 3.0A Programmable Output Current Limit for Boost Mode
- Integrated Short Circuit Protection and Output Over Voltage Protection for Boost Mode

### APPLICATIONS

- Sub-Battery Applications
- Power-bank Applications for Smart-Phone, Tablet and Other Portable Devices

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**Table 1: Operation Mode**

Power Source		MODE	EN	Operating Mode	ACOK	Q1,Q2	Q3	Q4
VIN	PWIN							
$V_{BATT}+300mV < V_{IN} < 6V$	PWIN>0.8V	X	Low	Only Pass Through Mode	Low	On	Off	Off
			High	Charging Mode		On	SW	SW
$V_{IN} < V_{BATT}+300mV$	X	High	X	Boost Discharge Mode	High	Off	SW	SW
X	PWIN<0.8V							
X	PWIN<0.8V	Low	X	SYS Force-off Mode	High	Off	Off	Off
$V_{IN} > 6V$	X			Input OVP				
$V_{IN} < 2V$	X			Sleep Mode				

X=Don't Care.

On = Fully Turn On

Off = Fully Off

SW = Switching

### ORDERING INFORMATION

Part Number	Package	Top Marking
MP2636GR	QFN-30 (4mmx4mm)	See Below

\* For Tape & Reel, add suffix –Z (e.g. MP2636GR–Z)

### TOP MARKING

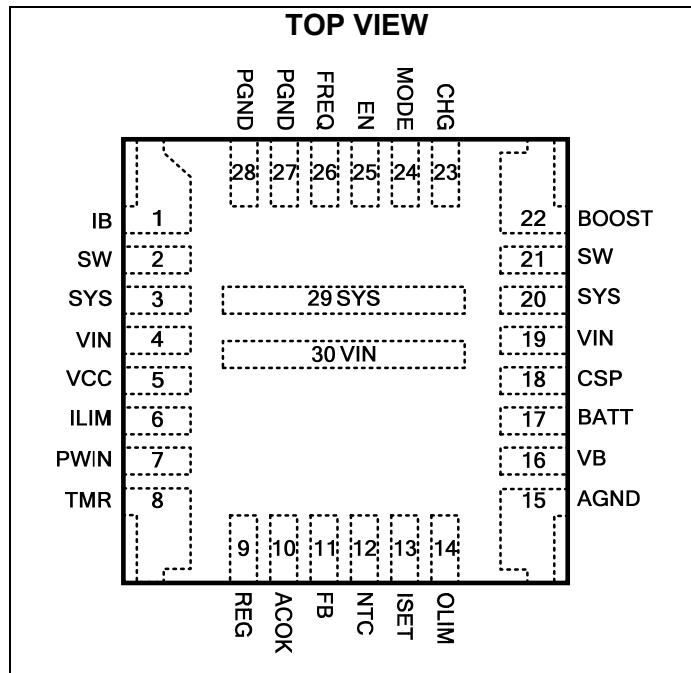
**MPSYWW**

**MP2636**

**LLLLLL**

MPS: MPS prefix;  
 Y: year code;  
 WW: week code;  
 MP2636: part number;  
 LLLLLL: lot number;

### PACKAGE REFERENCE



**ABSOLUTE MAXIMUM RATINGS** <sup>(1)</sup>

VIN to PGND .....	-0.3V to +20V
SYS to PGND .....	-0.3V to +6.5V
SW to PGND .....	-0.3V (-2V for 20ns)
.....	To + 6.5V (8.8V for 20ns)
BATT to PGND .....	-0.3V to +5V
<b>ACOK, CHG, BOOST to AGND</b>	
.....	-0.3V to +6.5V
All Other Pins to AGND.....	-0.3V to +6.5V
Continuous Power Dissipation (T <sub>A</sub> =+25°C) <sup>(2)</sup>	
.....	2.97W
Junction Temperature .....	150°C
Lead Temperature .....	260°C
Storage Temperature.....	-65°C to +150°C

**Recommended Operating Conditions** <sup>(3)</sup>

Supply Voltage VIN.....	4.5V to 6V
Battery Voltage BATT .....	2.5V to 4.35V
Operating Junction Temp (T <sub>J</sub> )..	-40°C to +125°C

<b>Thermal Resistance</b> <sup>(4)</sup>	<b>θ<sub>JA</sub></b>	<b>θ<sub>JC</sub></b>	
QFN-30 (4mmx4mm).....	42	9	°C/W

**Notes:**

- 1) Exceeding these ratings may damage the device.
- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub> (MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub> (MAX) = (T<sub>J</sub> (MAX)-T<sub>A</sub>)/θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

## ELECTRICAL CHARACTERISTICS

$V_{IN} = 5V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
IN to SYS NMOS On Resistance	$R_{IN\ to\ SYS}$			30		m $\Omega$
High-side PMOS On Resistance	$R_{H\_DS}$			25		m $\Omega$
Low-side NMOS On Resistance	$R_{L\_DS}$			25		m $\Omega$
Peak Current Limit for High-side PMOS	$I_{PEAK\_HS}$	Charger CC Mode/ Boost Mode		8		A
		Charger TC Mode		4		
Peak Current Limit for Low-side NMOS	$I_{PEAK\_LS}$	Boost Mode		5.5		A
Operating Frequency	$F_{SW}$	FREQ=LOW		600		kHz
VCC UVLO	$V_{CC\_UVLO}$		2	2.2	2.4	V
VCC UVLO Hysteresis				85		mV
PWIN Threshold	$V_{PWIN\_L}$		0.75	0.8	0.85	V
PWIN Threshold Hysteresis				45		mV
<b>Charge Mode</b>						
Input Quiescent Current	$I_{IN}$	EN=4V, BATT Float			2.5	mA
		EN=0V,			1.5	
Trickle Charge Current	$I_{TC}$	RS1 = 20m $\Omega$ , R <sub>ISSET</sub> < 60k, as percentage of I <sub>CC</sub>		10		%
Minimum Trickle Charge Current	$I_{TC\_MIN}$	RS1 = 20m $\Omega$ , R <sub>ISSET</sub> >= 60k		200		mA
Trickle Charge Voltage Threshold	$V_{BATT\_TC}$	Connect VB to GND	2.91	3.01	3.112	V
		Leave VB floating	2.94	3.043	3.145	
		Connect VB to High Logic	2.84	2.94	3.04	
Trickle Charge Hysteresis		V <sub>BATT</sub> falling		240		mV
Constant Charge (CC) Current	$I_{CC}$	RS1 = 20m $\Omega$ , R <sub>ISSET</sub> = 60.4k	1725	1987	2250	mA
		RS1 = 20m $\Omega$ , R <sub>ISSET</sub> = 47.5k	2225	2525	2825	
Termination Charge Current	$I_{BF}$	I <sub>CHG</sub> falling		150		mA
Terminal Battery Voltage	$V_{BATT\_FULL}$	Connect VB to GND	4.278	4.3	4.321	V
		Leave VB floating	4.328	4.35	4.371	
		Connect to VCC	4.179	4.2	4.221	
Recharge Threshold	$V_{RECH}$	Connect VB to GND	4.023	4.085	4.147	V
		Leave VB floating	4.07	4.132	4.195	
		Connect to VCC	3.93	3.99	4.05	

**ELECTRICAL CHARACTERISTICS** *(continued)*
 $V_{IN} = 5V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
Recharge Threshold Hysteresis		Connect VB to GND		200		mV
		Leave VB floating		200		
		Connect to VCC		200		
Battery Over Voltage Threshold		As percentage of $V_{BATT\_FULL}$		102.5		%
<b>Input Voltage and Input Current Based Power Path</b>						
Input Voltage Regulation Reference	$V_{REG}$		1.18	1.2	1.22	V
Input Current Limit	$I_{IN\_LMT}$	$R_{ILIM} = 86.6k$	380	450	500	mA
		$R_{ILIM} = 51k$	720	810	900	
		$R_{ILIM} = 13k$	2940	3270	3600	
Input Over Current Threshold	$I_{IN\_OCP}$	$R_{ILIM} = 86.6k$		593		mA
		$R_{ILIM} = 51k$		1000		mA
		$R_{ILIM} = 13k^{(5)}$		4.09		A
Input Over Current Shutdown Blanking Time <sup>(5)</sup>	$T_{INOCBLK}$			120		$\mu s$
Input Over Current Shutdown Recover Time <sup>(5)</sup>	$T_{INRECVR}$			100		ms
<b>Boost Mode</b>						
SYS Voltage Range			4.2		6	V
Feedback Voltage			1.18	1.2	1.22	V
Feedback Input Current		$V_{FB}=1V$			200	nA
SYS Over Voltage Protection Threshold for Boost	$V_{SYS(OVP)}$	Threshold over $V_{SYS}$ to turn off the converter during boost mode	5.8	6	6.2	V
SYS Over Voltage Protection Threshold Hysteresis		$V_{SYS}$ falling from $V_{SYS(OVP)}$		125		mV
Boost Quiescent Current		$I_{SYS} = 0$ , $V_{SYS} = 5V$ , $V_{FB} = 2.0V$ , MODE = high, BATT = 4.2V		430	500	$\mu A$



**ELECTRICAL CHARACTERISTICS** *(continued)*
 $V_{IN} = 5V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
Programmable Boost Output Current Limit Accuracy	$I_{OLIM}$	$V_{SYS} = 5V$ , $R_{S1} = 20m$ , $R_{OLIM} = 120k$	774	910	1046	mA
		$V_{SYS}=5V$ , $R_{S1} =20m$ , $R_{OLIM} = 47.5k$	2088	2320	2552	
SYS Over Current Blanking Time <sup>(5)</sup>	$T_{SYSOCLBK}$			120		$\mu s$
SYS Over Current Recover Time <sup>(5)</sup>	$T_{SYSRECVR}$			1.5		ms
Weak Battery Threshold	$V_{BATT(LOW)}$	During boosting		2.5		V
		Before Boost starts		2.9	3.05	
<b>Sleep Mode</b>						
Battery Leakage Current	$I_{BATT}$	$V_{BATT}=4.2V$ , SYS Float, $V_{IN}=GND$ , MODE=0V			40	$\mu A$
<b>Indication &amp; Logic</b>						
ACOK, CHG, BOOST pin output low voltage		Sinking 1.5mA			450	mV
ACOK, CHG, BOOST pin leakage current		Connected to 5V			1	$\mu A$
NTC and Time-out Fault Blinking Frequency <sup>(5)</sup>		$C_{TMR} = 0.1\mu F$ , $I_{CHG} = 1A$		13.7		Hz
EN, MODE Input Logic Low Voltage					0.4	V
EN, MODE Input High Voltage			1.4			V
FREQ Input Logic Low Voltage					0.8	V
FREQ Input Logic High Voltage			1.8			V
VB Input Logic Low Voltage					0.8	V
VB Input Logic High Voltage			1.8			V
IB Voltage Output		$I_{CHG}=1A$ in charge mode		0.36		V
		$I_{DIS}=1A$ in boost mode		0.40		V
<b>Protection</b>						
Trickle Charge Time		$C_{TMR}=0.1\mu F$ , Stay in TC Mode, $I_{CHG}= 2A$		17		Mins
Total Charge Time		$C_{TMR}=0.1\mu F$ , $I_{CHG}= 2.5A$		140		Mins

**ELECTRICAL CHARACTERISTICS** *(continued)*

V<sub>IN</sub> = 5V, T<sub>A</sub> = +25°C, unless otherwise noted.

Parameters	Symbol	Condition	Min	Typ	Max	Units
NTC Low Temp Rising Threshold		R <sub>NTC</sub> =NCP18XH103(0°C)	65.6%	66.6%	67.6%	V <sub>CC</sub>
NTC Low Temp Rising Threshold Hysteresis				1%		
NTC High Temp Rising Threshold		R <sub>NTC</sub> =NCP18XH103(50°C)	34%	35%	36%	V <sub>CC</sub>
NTC Low Temp Rising Threshold Hysteresis				1%		
Charging Current Fold-back Threshold <sup>(5)</sup>		Charge Mode		120		°C
Thermal Shutdown Threshold <sup>(5)</sup>				150		°C

**Notes:**

5) Guaranteed by Design

## PIN FUNCTIONS

Pin #	Name	Description
1	IB	Charge Current Represent. The voltage at this pin indicates the charge current to the battery in charge mode and discharge current out of the battery in boost mode.
2, 21	SW	Switch Output Node. It is recommended not to place Via's on the SW plane during PCB layout.
3, 20, 29	SYS	System Output. <b>A minimum of 22<math>\mu</math>F ceramic cap is required to be put as close as possible to the SYS and PGND pins. Total capacitance should NOT be lower than 44<math>\mu</math>F.</b>
4, 19, 30	VIN	Adapter Input. Place a bypass capacitor close to this pin to prevent large voltage spikes.
5	VCC	Internal Circuit Power Supply. Bypass this pin to GND with a 100nF ceramic capacitor. <b>This Pin CANNOT carry any external load.</b>
6	ILIM	Input Current Set. Connect to GND with an external resistor to program input current limit in charge mode.
7	PWIN	Input pin to detect the presence of valid input power. Pulling this pin to GND will turn off the IN-to-SYS pass through MOSFET.
8	TMR	Oscillator Period Timer. Connect a timing capacitor between this pin and GND to set the oscillator period for charge timer. Short to GND to disable the Timer function.
9	REG	Input voltage feedback for the input voltage regulation loop. Connect to tap of an external resistor divider from VIN to GND to program the input voltage regulation. Once the voltage at REG pin drops to the inner threshold, the charge current is reduced to maintain the input voltage at the regulation value.
10	ACOK	Valid Input Supply Indicator. Logic LOW at this pin indicates the presence of a valid power supply.
11	FB	System Voltage Feedback Input.
12	NTC	Negative Temperature Coefficient (NTC) Thermistor
13	ISET	Charge Current Set. Connect an external resistor to GND to program the charge current.
14	OLIM	Programmable Output-Current Limit for Boost mode. Connect an external resistor to GND to program the system current in Boost mode.
15	AGND	Analog Ground
16	VB	Programmable Battery-Full Voltage. Connect to GND for 4.3V, leave floating to 4.35V, and connect to logic HIGH for 4.2V.
17	BATT	Positive Battery Terminal / Battery Charge Current Sense Negative Input.
18	CSP	Battery Charge Current Sense Positive Input.
22	BOOST	Boost operation indicator. Logic LOW indicates boost operation. The pin becomes an open drain when the part operates at charge mode or sleep mode.
23	CHG	Charging Completion Indicator. Logic LOW indicates charge mode. The pin becomes an open drain once the charging has completed or is suspended.
24	MODE	Mode Select. Logic HIGH→boost mode. Logic LOW→sleep mode. Active only when $\overline{\text{ACOK}}$ is high (Input power is not available).

**PIN FUNCTIONS** *(continued)*

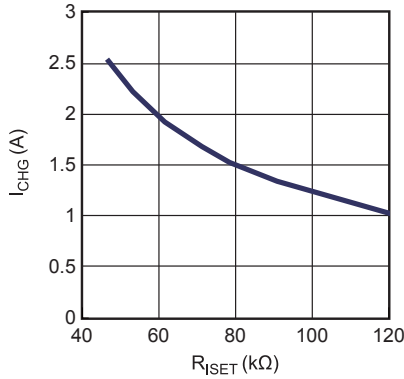
Pin #	Name	Description
25	EN	Charging Control Input. Logic HIGH enables charging. Logic LOW disables charging. Active only when $\overline{\text{ACOK}}$ is low (Input power is Ok)
26	FREQ	Connect to GND to figure the operating frequency to 600kHz.
27, 28	PGND	Power Ground.

## TYPICAL CHARACTERISTICS

$V_{IN} = 5V$ ,  $C_{IN} = C_{BATT} = C_{SYS} = C_2 = 22\mu F$ ,  $L_1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C_4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, unless otherwise noted.

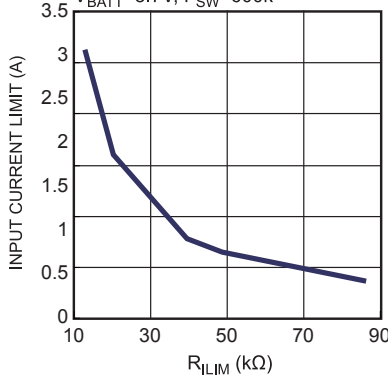
**Programmable Charge Current, Charge Mode**

$V_{IN}=5V$ ,  $V_{BATT\_FULL}=4.2V$ ,  
 $V_{BATT}=3.7V$ ,  $F_{SW}=600k$



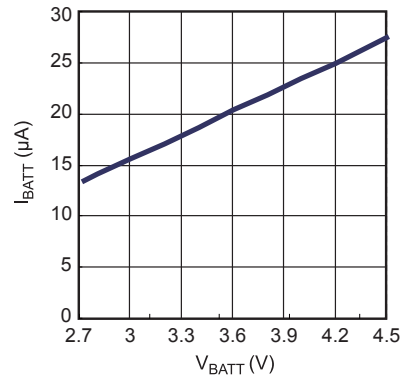
**Programmable Input Current Limit, Charge Mode**

$V_{IN}=5V$ ,  $V_{BATT\_FULL}=4.2V$ ,  
 $V_{BATT}=3.7V$ ,  $F_{SW}=600k$



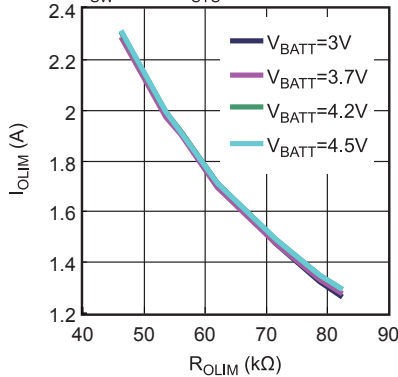
**Battery Leakage Current, Sleep Mode**

MODE=Low



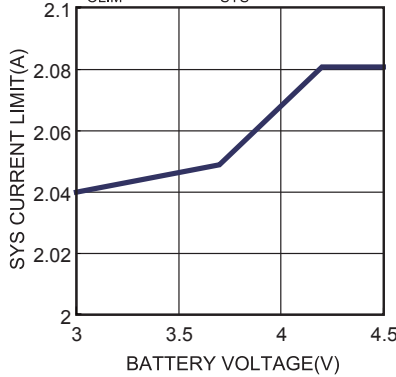
**Programmable Output Current Limit, Boost Mode**

$F_{SW}=600k$ ,  $V_{SYS}=5V$

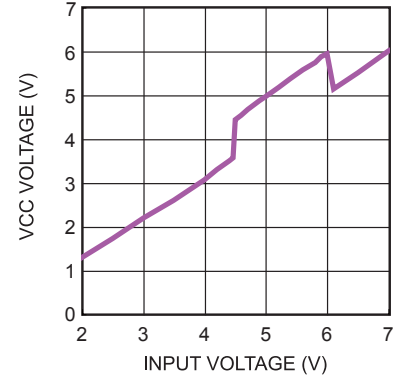


**Programmable Output Current Limit vs. Battery**

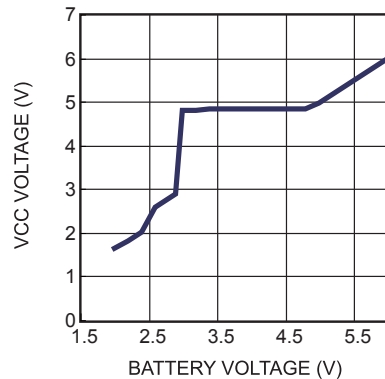
$R_{OLIM}=53.6k\Omega$ ,  $V_{SYS}=5V$



**VCC @ Charge Mode**

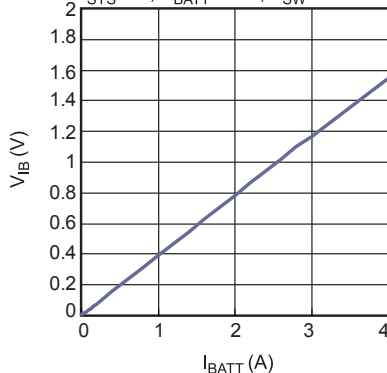


**VCC @ Boost Mode**



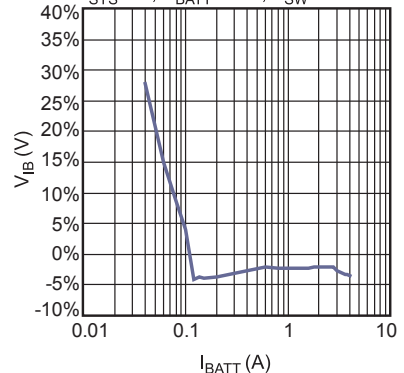
**IB Voltage vs. Battery Current @ Boost Mode**

$V_{SYS}=5V$ ,  $V_{BATT}=3.7V$ ,  $F_{SW}=600kHz$



**Accuracy of the IB Monitor @ Boost Mode**

$V_{SYS}=5V$ ,  $V_{BATT}=3.7V$ ,  $F_{SW}=600kHz$



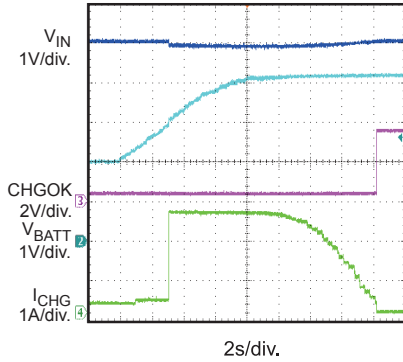


## TYPICAL PERFORMANCE CHARACTERISTICS

$V_{IN} = 5V$ ,  $C_{IN} = C_{BATT} = C_{SYS} = C_2 = 22\mu F$ ,  $L_1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C_4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, Unless Otherwise Noted.

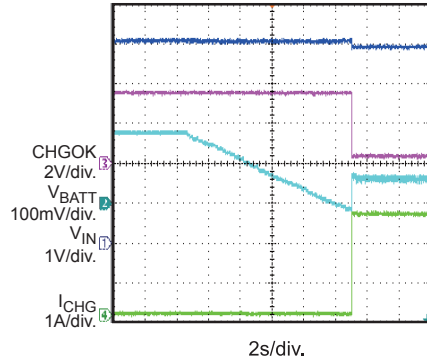
**Battery Charge Curve**

$V_{BATT\_FULL} = 4.2V$



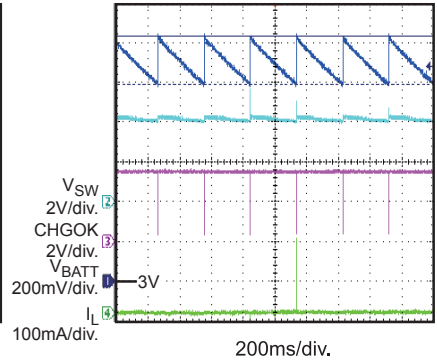
**Auto Recharge**

$V_{BATT\_FULL} = 4.2V$



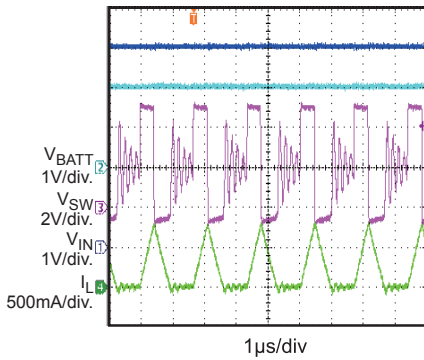
**Battery Float Steady State**

$V_{BATT\_FULL} = 4.2V$



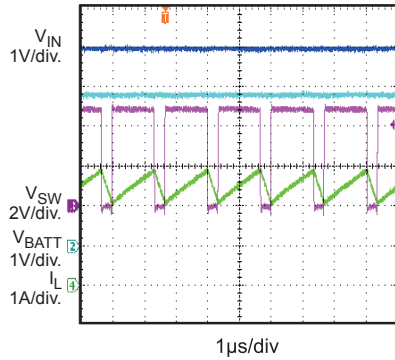
**TC Charge Steady State**

$V_{BATT\_FULL} = 4.2V$ ,  $V_{BATT} = 2V$ ,  
 $F_{SW} = 600kHz$



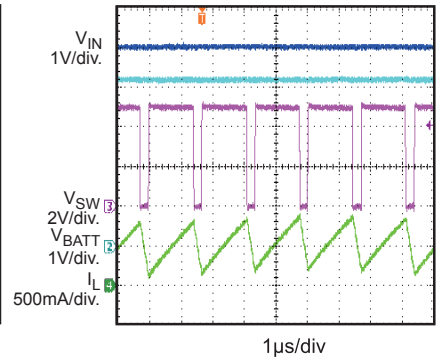
**CC Charge Steady State**

$V_{BATT\_FULL} = 4.2V$ ,  $V_{BATT} = 3.7V$ ,  
 $F_{SW} = 600kHz$



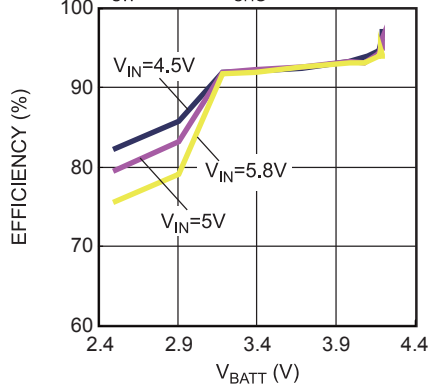
**CV Charge Steady State**

$V_{BATT\_FULL} = 4.2V$ ,  $V_{BATT} = 4.2V$ ,  
 $F_{SW} = 600kHz$



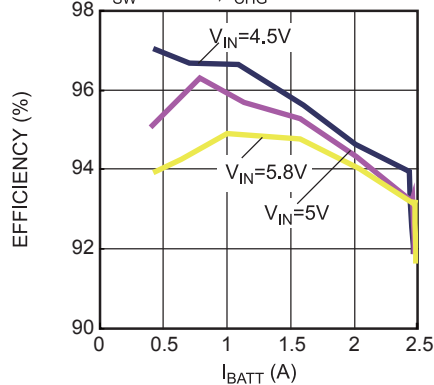
**Constant Current Charge Efficiency**

$V_{BATT\_FULL} = 4.2V$ ,  $V_{BATT} = 2.5-4.2V$ ,  
 $F_{SW} = 600kHz$ ,  $I_{CHG} = 2.5A$



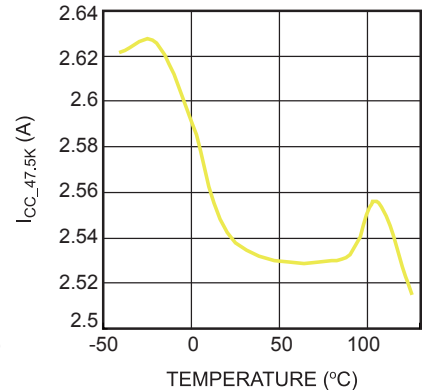
**Constant Voltage Charge Efficiency**

$V_{BATT\_FULL} = 4.2V$ ,  $V_{BATT} = 4.2V$ ,  
 $F_{SW} = 600kHz$ ,  $I_{CHG} = 2.5A$



**CC Charge Current vs. Temperature**

$R_{ISET} = 47.5k\Omega$

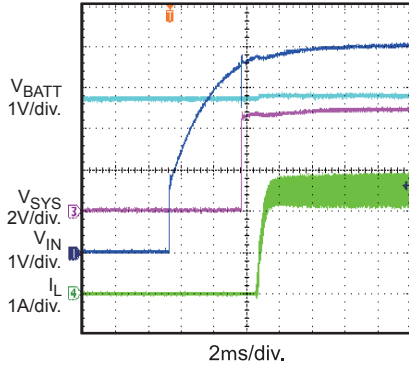


**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$V_{IN} = 5V$ ,  $C_{IN} = C_{BATT} = C_{SYS} = C_2 = 22\mu F$ ,  $L_1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C_4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, Unless Otherwise Noted.

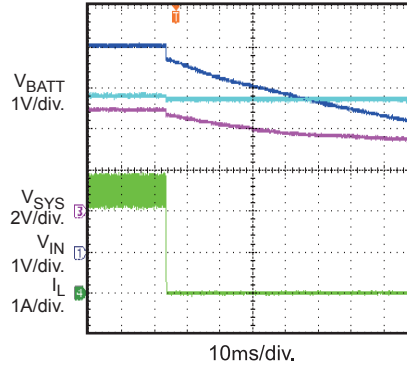
**Power On, Charge Mode**

$V_{BATT\_FULL}=4.2V$ ,  $V_{BATT}=3.7V$ ,  
 $I_{CHG}=2.5A$



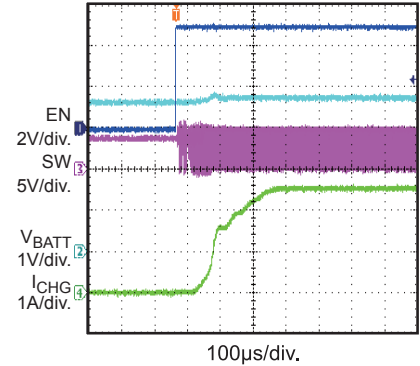
**Power Off, Charge Mode**

$V_{BATT\_FULL}=4.2V$ ,  $V_{BATT}=3.7V$ ,  
 $I_{CHG}=2.5A$



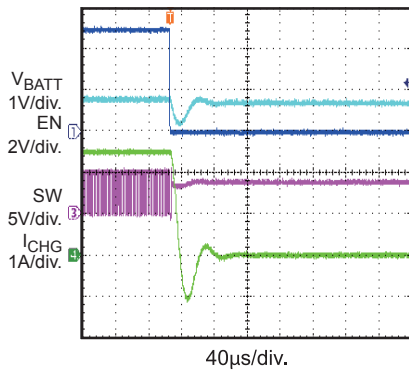
**EN On, Charge Mode**

$V_{BATT\_FULL}=4.2V$ ,  $V_{BATT}=3.7V$ ,  
 $I_{CHG}=2.5A$



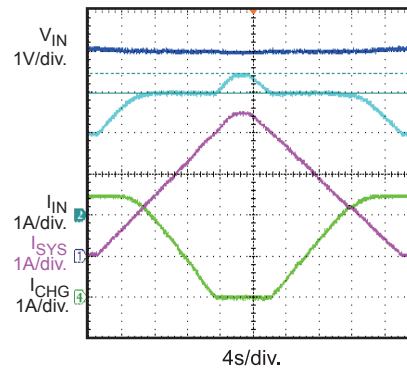
**En Off, Charge Mode**

$V_{BATT\_FULL}=4.2V$ ,  $V_{BATT}=3.7V$ ,  
 $I_{CHG}=2.5A$



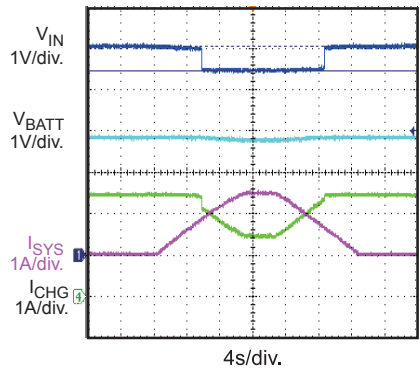
**Input Current Limit**

$V_{BATT\_FULL}=4.2V$ ,  $V_{BATT}=3.7V$



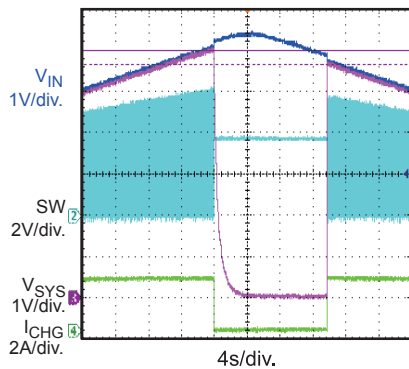
**Input Voltage Clamp**

$V_{BATT\_FULL}=4.2V$ ,  $V_{BATT}=3.7V$



**Input Over Voltage Protection**

$V_{IN}=5V$  to  $6.5V$ ,  $V_{BATT}=3.7V$ ,  
Enabled Charger

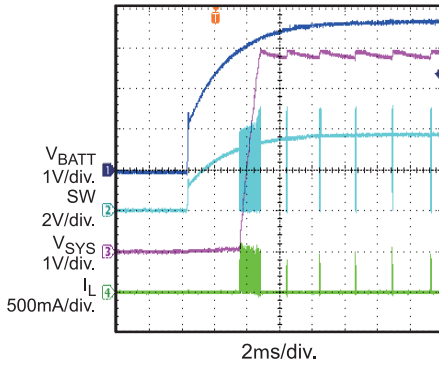


**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$V_{IN} = 0V$ ,  $V_{BATT}=3.7V$ ,  $C_{IN} = C_{BATT} = C_{SYS} = C_2 = 22\mu F$ ,  $L_1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C_4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, Unless Otherwise Noted.

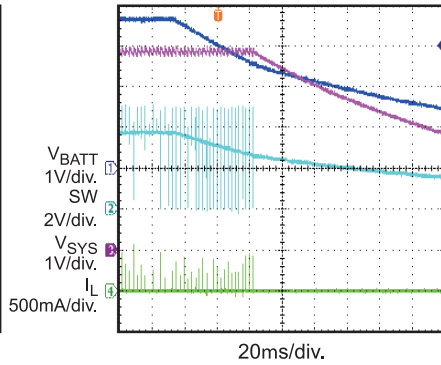
**Power On, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
No SYS Load



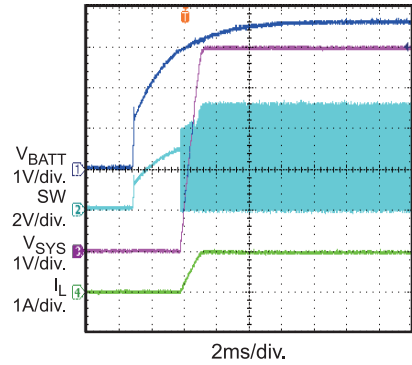
**Power Off, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
No SYS Load



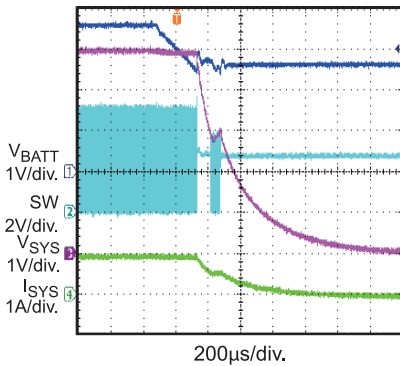
**Power On, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
 $R_{SYS\_LOAD}=5\Omega$



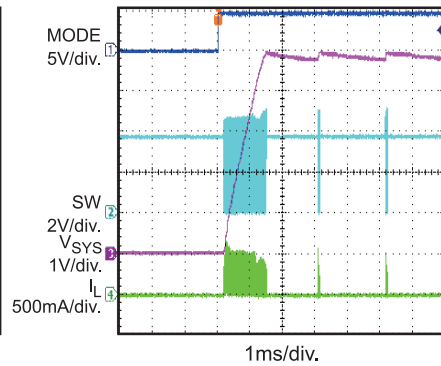
**Power Off, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
 $R_{SYS\_LOAD}=5\Omega$



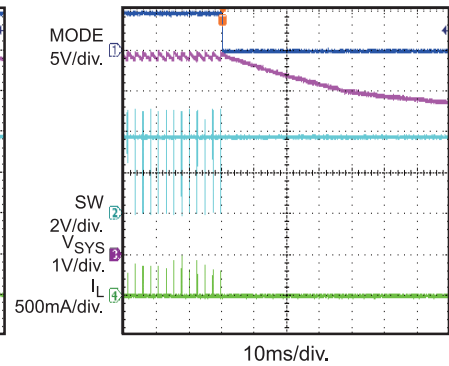
**Mode On, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
No SYS Load



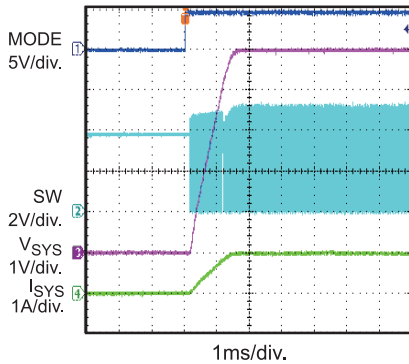
**Mode Off, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
No SYS Load



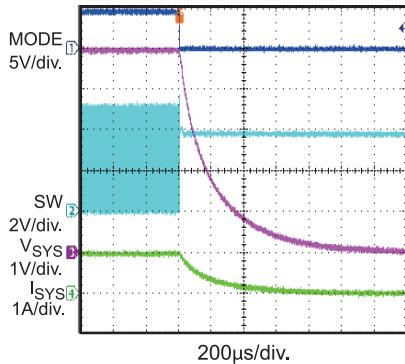
**Mode On, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
 $R_{SYS\_LOAD}=5\Omega$



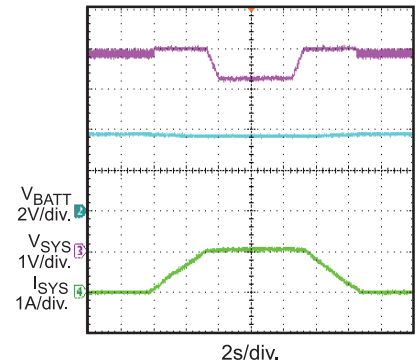
**Mode Off, Boost Mode**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
 $R_{SYS\_LOAD}=5\Omega$



**SYS Output Current Limit**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  
 $I_{OLIM\_SET}=1A$

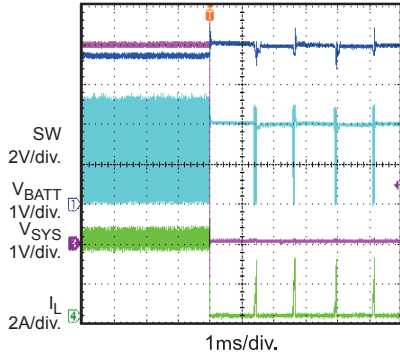


**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$V_{IN} = 0V$ ,  $V_{BATT}=3.7V$ ,  $C_{IN} = C_{BATT} = C_{SYS} = C2 = 22\mu F$ ,  $L1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, Unless Otherwise Noted.

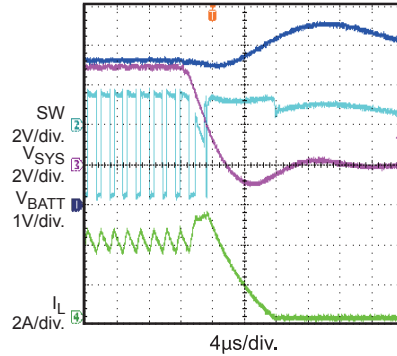
**SYS Short Circuit Entry**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  $I_{SYS}= 2.6A$



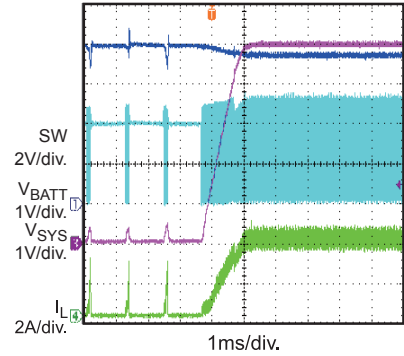
**SYS Short Circuit Entry**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  $I_{SYS}= 2.6A$



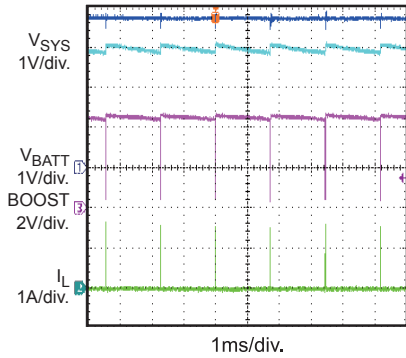
**SYS Short Circuit Recovery**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  $I_{SYS}= 2.6A$



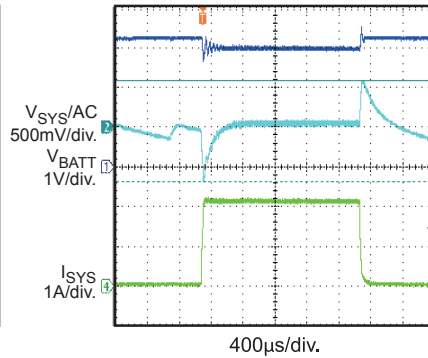
**SYS Over Voltage Protection**

$V_{SYS\_SET}=6.5V$ ,  $V_{BATT}=3.7V$



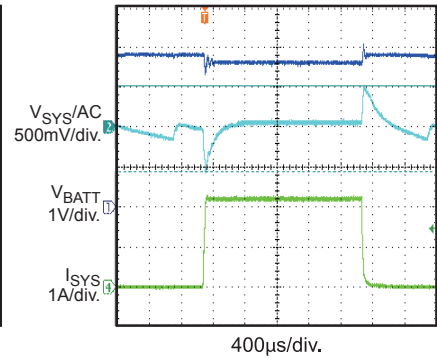
**SYS Load Transient**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3V$ ,  $I_{SYS}= 0A$  to  $2.2A$



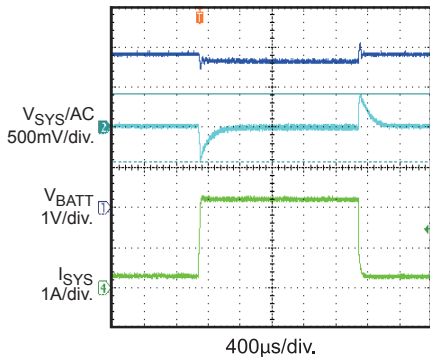
**SYS Load Transient**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  $I_{SYS}= 0A$  to  $2.2A$



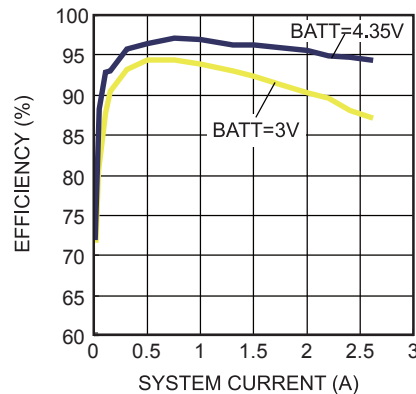
**SYS Load Transient**

$V_{SYS\_SET}=5V$ ,  $V_{BATT}=3.7V$ ,  $I_{SYS}= 0.3A$  to  $2.2A$



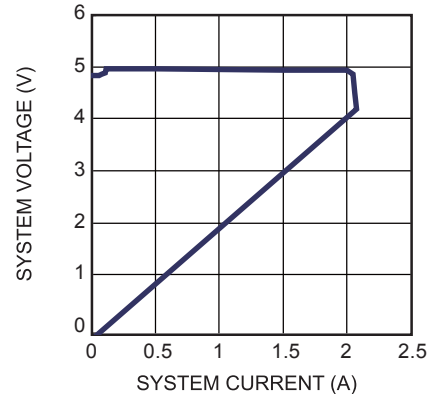
**Boost Efficiency**

$V_{SYS\_SET}=5V$ ,  $F_S=600kHz$



**Boost Output V-I Curve**

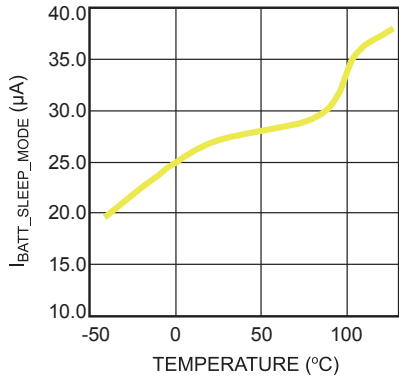
$V_{BATT}=3.7V$ ,  $V_{SYS}=5V$ ,  $R_{OLIM}=53.6k\Omega$



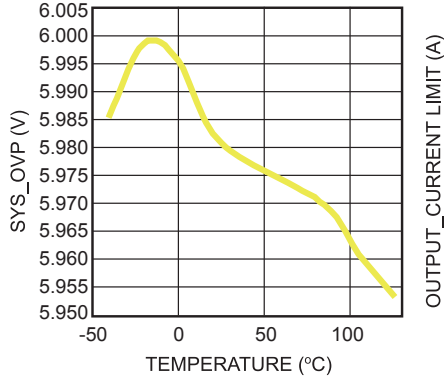
**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$V_{IN} = 5V$  (typ.),  $V_{BATT}=3.7V$  (typ.),  $C_{IN} = C_{BATT} = C_{SYS} = C2 = 22\mu F$ ,  $L1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, Unless Otherwise Noted.

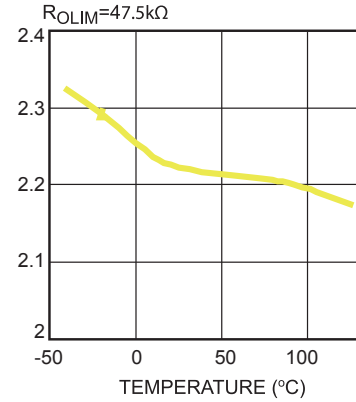
**Sleep\_Mode\_Battery Current vs. Temperature**



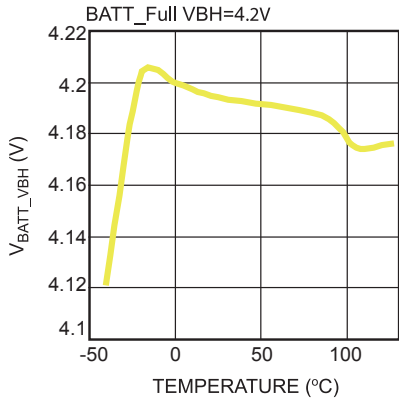
**SYS\_OVP vs. Temperature**



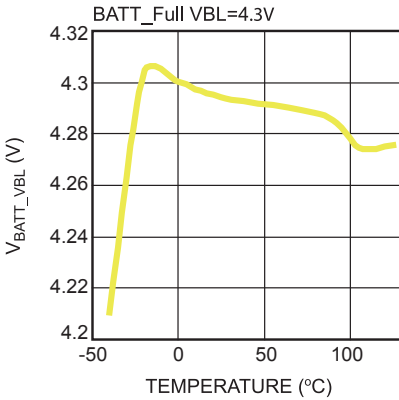
**Output\_Current\_Limit\_2.2A vs. Temperature**



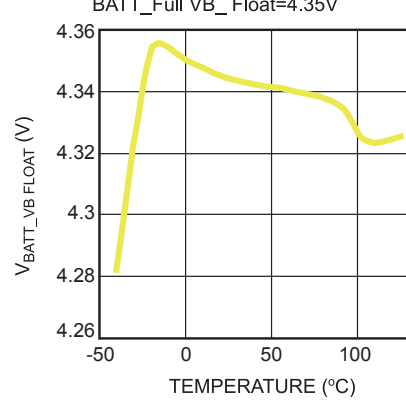
**BATT\_Full VBH vs. Temperature**



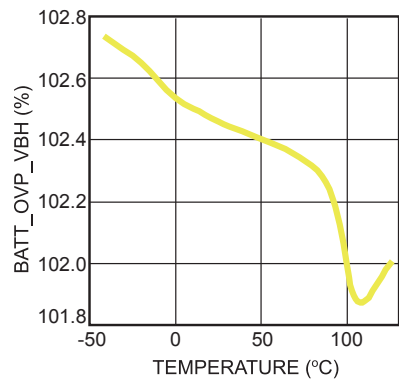
**BATT\_Full VBL vs. Temperature**



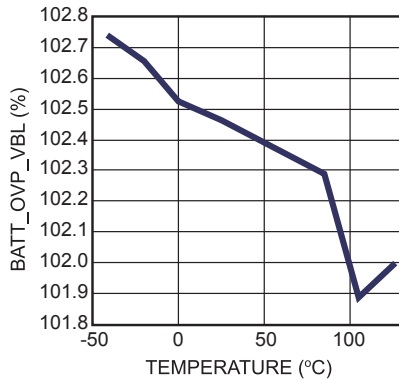
**BATT\_Full VB Float vs. Temperature**



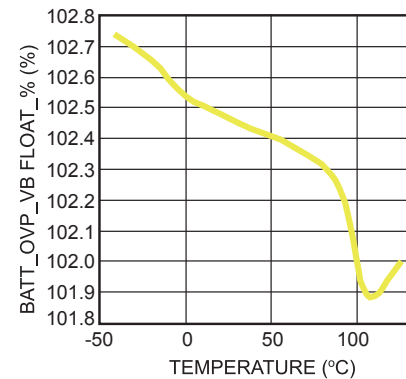
**BATT\_OVP\_VBH\_% vs. Temperature**



**BATT\_OVP\_VBL\_% vs. Temperature**



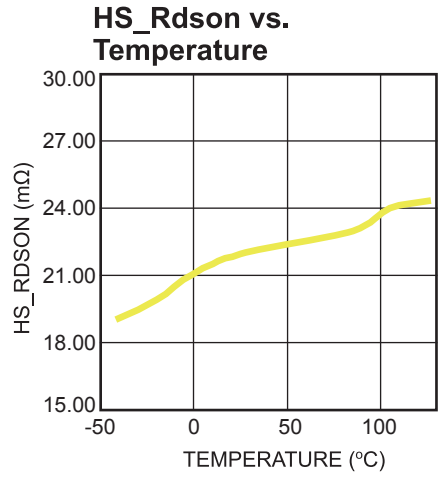
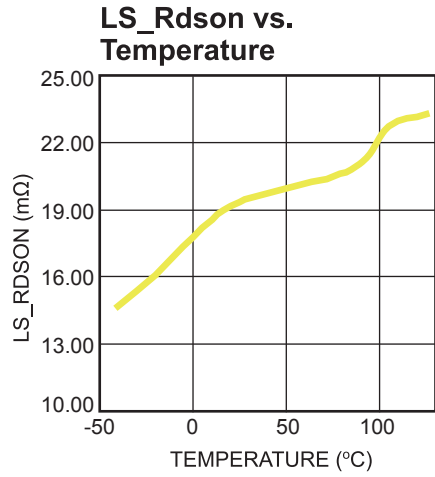
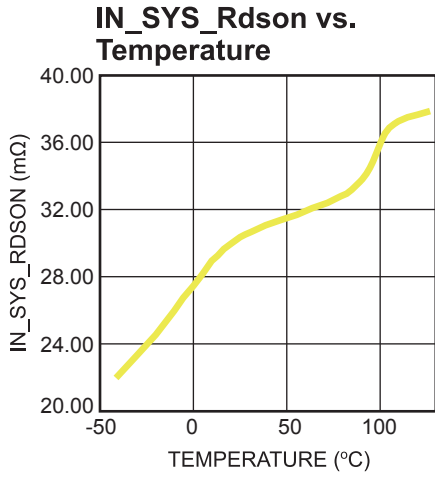
**BATT\_OVP\_VB Float\_% vs. Temperature**



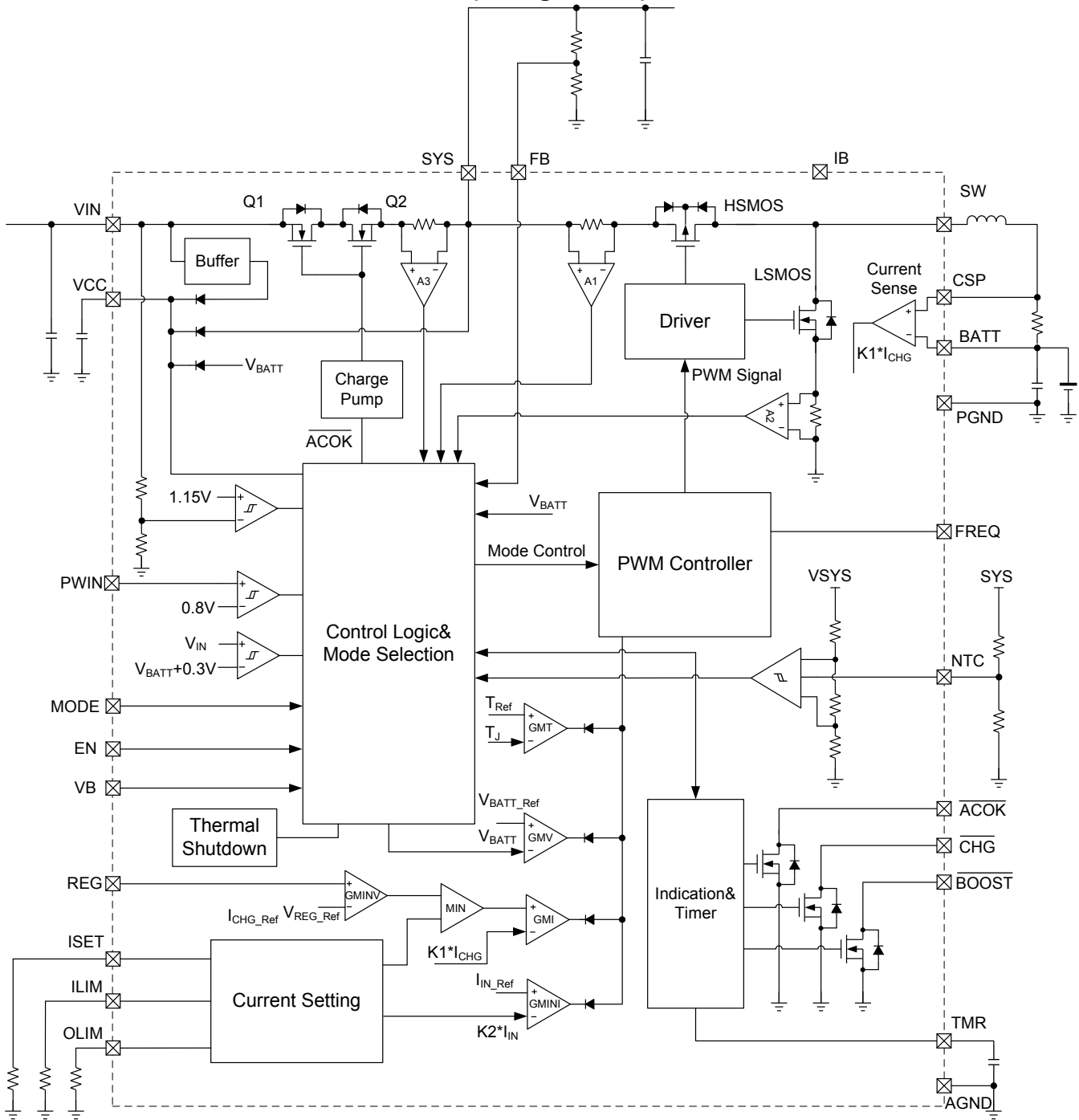


**TYPICAL PERFORMANCE CHARACTERISTICS** *(continued)*

$V_{IN} = 5V$  (typ.),  $V_{BATT}=3.7V$  (typ.),  $C_{IN} = C_{BATT} = C_{SYS} = C2 = 22\mu F$ ,  $L1 = 1.5\mu H$ ,  $RS1 = 20m\Omega$ ,  $C4 = C_{TMR} = 0.1\mu F$ , Battery Simulator, Unless Otherwise Noted.



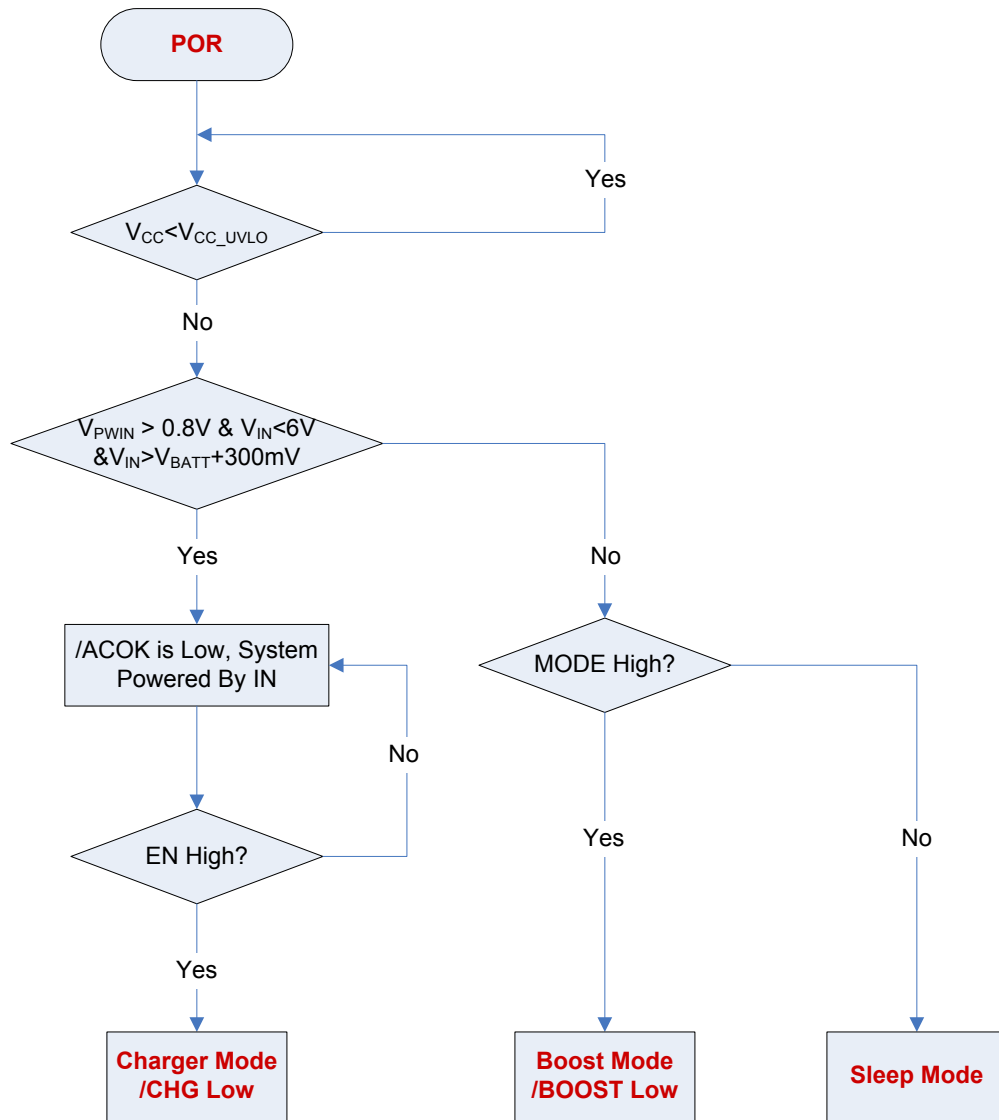
**FUNCTIONAL BLOCK DIAGRAM (Charge Mode)**



**Figure 1 : Functional Block Diagram in Charger Mode**

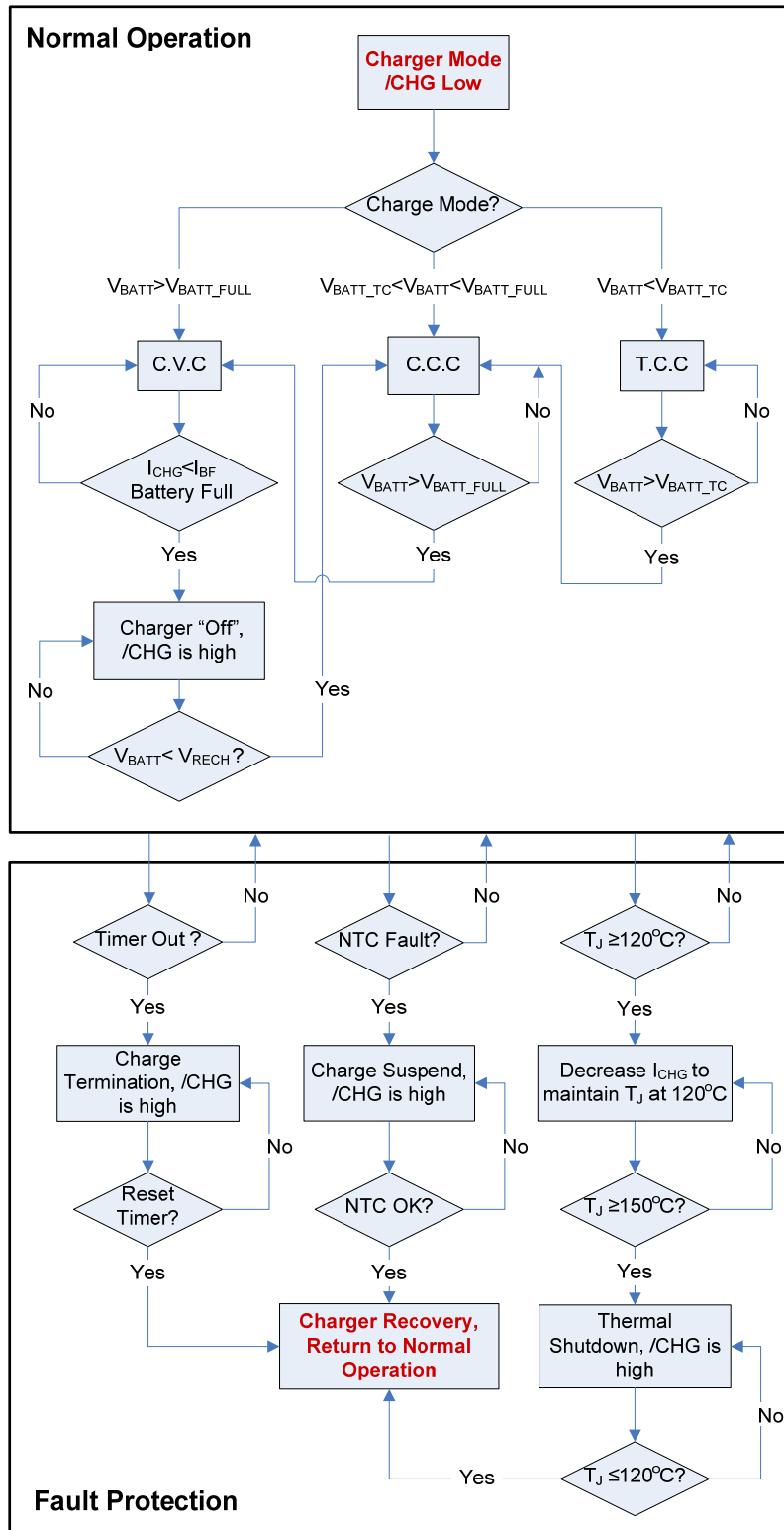


**OPERATION FLOW CHART**



**Figure 3: Mode Selection Flow Chart**

**OPERATION FLOW CHART (Continued)**



**Figure 4: Operation Flow Chart in Charger Mode**



OPERATION FLOW CHART (Continued)

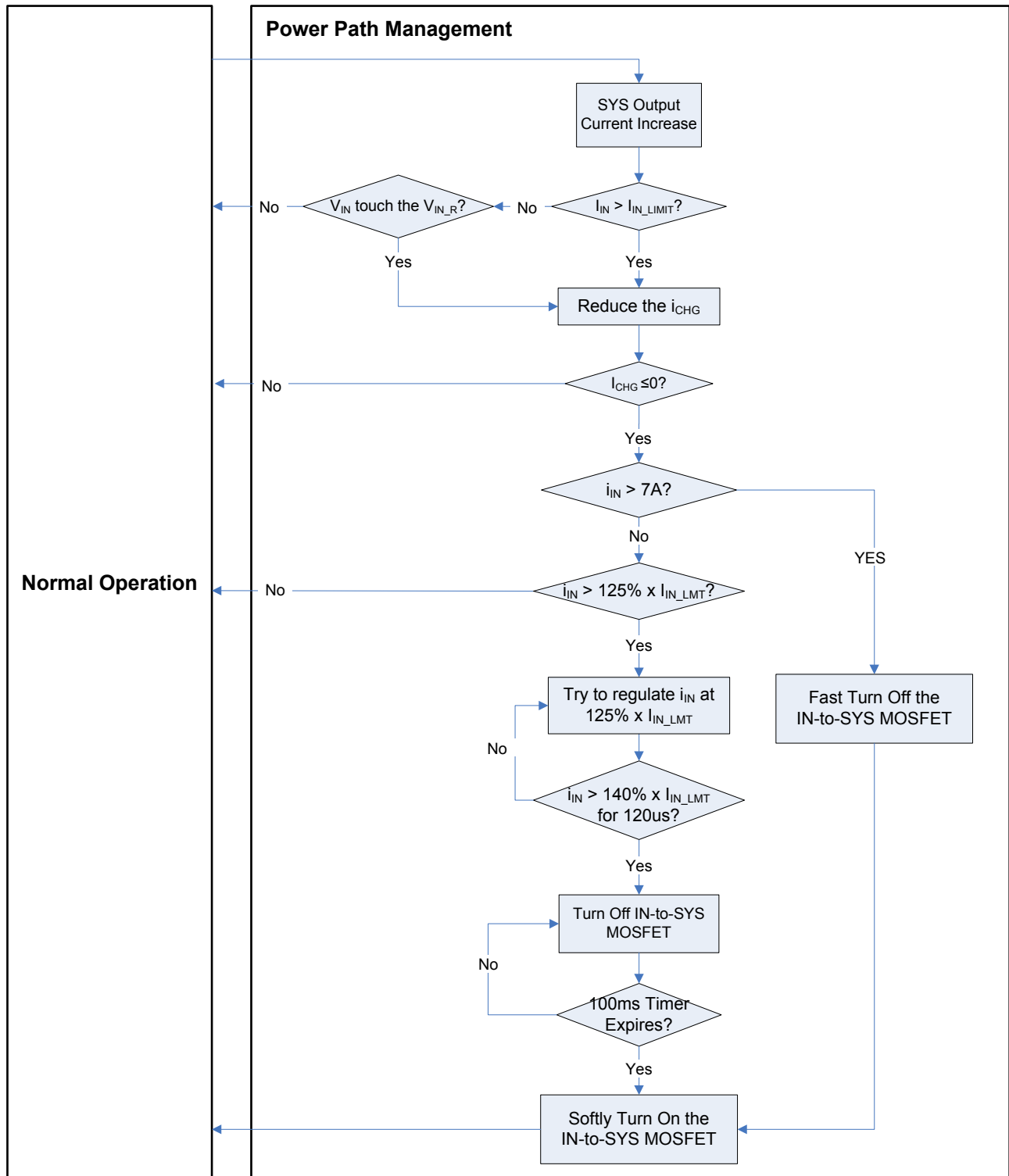
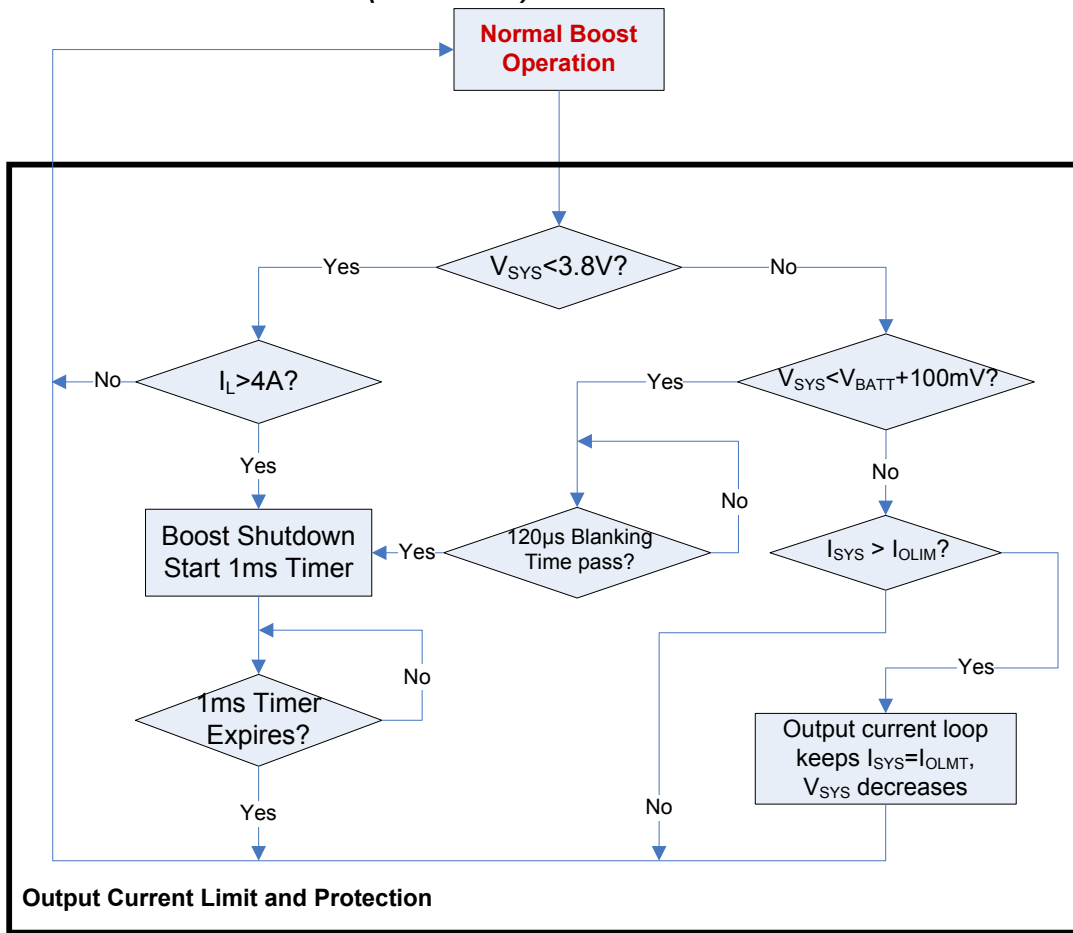


Figure 5: Power-path Management in Charge Mode

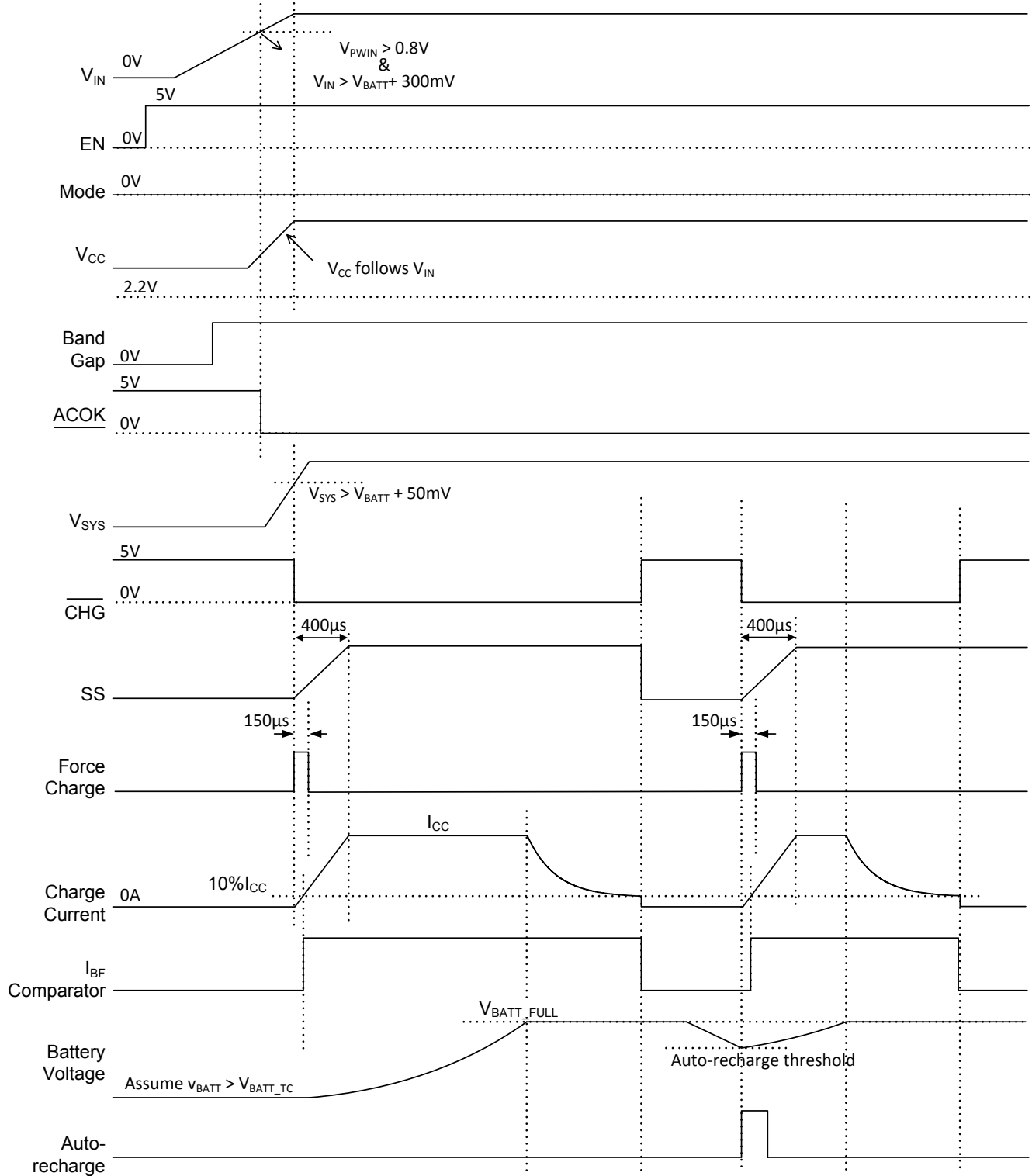
**OPERATION FLOW CHART (Continued)**



**Figure 6: Operation Flow Chart in Boost Mode**

### START UP TIME FLOW IN CHARGE MODE

Condition: EN = 5V, Mode = 0V, /ACOK and /CHG are always pulled up to an external constant 5V



**Figure 7: Input Power Start-up Time Flow in Charge Mode**